

### Data and signal line chokes

Common-mode chokes, ring core 2.2 ... 47 mH, 100 mA, +60 °C

Series/Type: B82791G15/H15

Date: October 2008, October 2011

© EPCOS AG 2015. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



#### Data and signal line chokes

#### B82791G15/H15

#### Common-mode chokes, ring core

Rated voltage 42 V AC/80 V DC Rated inductance 2.2 mH to 47 mH Rated current 100 mA

#### Construction

- Current-compensated ring core double choke
- Ferrite core
- Polycarbonate case (UL 94 V-0)

#### **Features**

- Without potting
- Vertical or horizontal version
- Suitable for wave soldering
- RoHS-compatible

#### **Application**

Suppression of asymmetrical interference coupled in on data lines, already effective at 10 kHz, e.g. in:

- Telephone lines (analog, ISDN)
- Interfaces with symmetrical data transmission
- Building services automation (EIB bus)
- Automation engineering

#### **Terminals**

- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Lead spacing 10 × 15 (mm) or 12.7 x 5.08/2.54 (mm)

#### Marking

Manufacturer, ordering code, rated inductance, rated current, graphic symbol (for B82791G15), date of manufacture (MMYY)

#### **Delivery mode**

Cardboard box



B82791G15



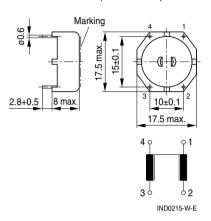
B82791H15

B82791G15/H15

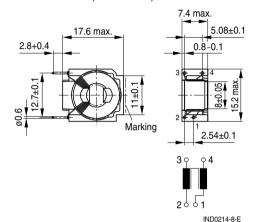
#### Common-mode chokes, ring core

#### Dimensional drawings and pin configurations

Horizontal version (B82791G15)



Vertical version (B82791H15)



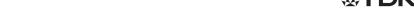
Tolerances to ISO 2768-M unless otherwise noted. Dimensions in mm.



#### Technical data and measuring conditions

Rated voltage V <sub>B</sub>	42 V AC (50/60 Hz) / 80 V DC		
Rated temperature T <sub>R</sub>	+60 °C		
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature		
Rated inductance L <sub>R</sub>	Measured with Agilent 4284A at 10 kHz, 0.1 mA, +20 °C Inductance is specified per winding.		
Inductance tolerance	±30% at +20 °C B82791H0015A016: -25/+35% at +20 °C		
Inductance decrease ΔL/L <sub>0</sub>	< 10% at DC magnetic bias with I <sub>R</sub> , +20 °C		
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4275A at 10 kHz, 5 mA, +20 °C, typical values		
DC resistance R <sub>typ</sub>	Measured at +20 °C, typ. values, specified per winding		
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: $(+245 \pm 5)$ °C, $(3 \pm 0.3)$ s Wetting of soldering area $\geq 95\%$ (to IEC 60068-2-20, test Ta)		
Resistance to soldering heat (wave soldering)	(+260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)		
Climatic category	40/125/56 (to IEC 60068-1)		
Storage conditions (packaged)	–25 °C +40 °C, ≤75% RH		
Weight	Approx. 3 g		

B82791G15/H15



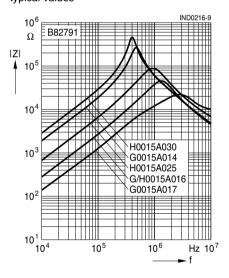
#### Common-mode chokes, ring core

#### Characteristics and ordering codes

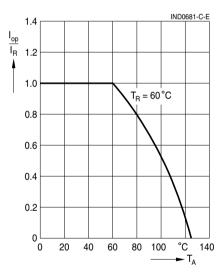
Data and signal line chokes

L <sub>R</sub>	L <sub>stray,typ</sub>	I <sub>R</sub>	R <sub>typ</sub>	V <sub>test</sub>	Ordering code	
mH	nH	mA	mΩ	V DC, 2 s	horizontal version	vertical version
2.2	500	100	300	1200	B82791G0015A017	_
4.7	900	100	850	1200	B82791G0015A016	B82791H0015A016
10	1200	100	1200	1200	_	B82791H0015A025
38	3300	100	5000	750	B82791G0015A014	_
47	2100	100	5100	750	_	B82791H0015A030

# Impedance IZI versus frequency f measured with windings in parallel at 20 °C, typical values



# Current derating I<sub>op</sub>/I<sub>R</sub> versus ambient temperature





#### Cautions and warnings

#### Current-compensated ring core double chokes

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there. Derating must be applied
    in the case the ambient temperature in application exceeds the rated temperature of the
    component.
  - Ensure the operation temperature of the component in application, which is the sum of the ambient temperature and the temperature rise owing to losses ("self-heating"), not to exceed the maximum value specified in the climatic category.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



#### Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.
  - We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.
- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2018-10

## **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

### **EPCOS / TDK:**

<u>B82791G0015A014</u> <u>B82791G0015A017</u> <u>B82791H0015A025</u> <u>B82791H0015A016</u> <u>B82791G0015A016</u> B82791H0015A030